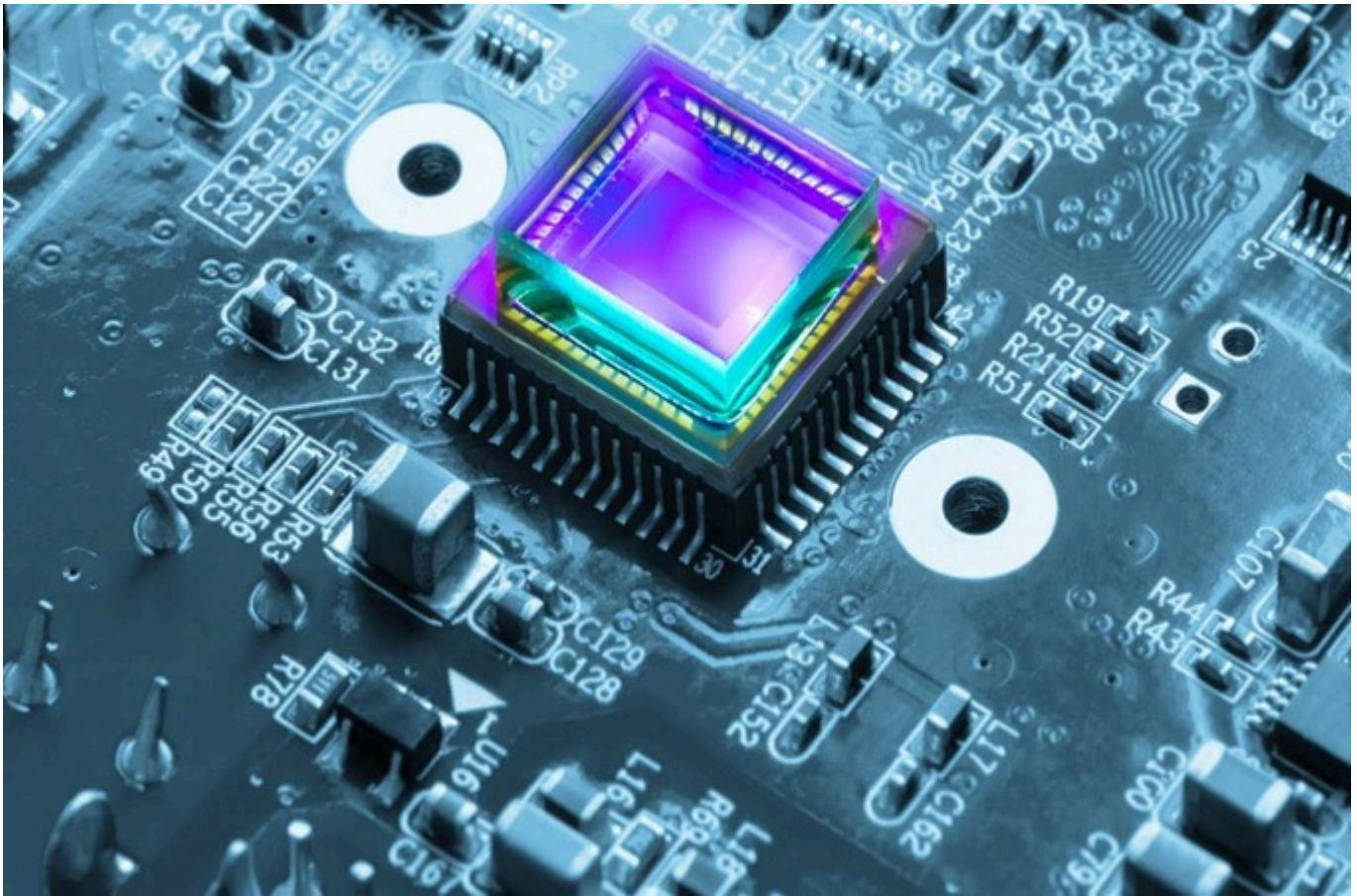


## Qualification Pack



# Package Design Engineer (Semiconductor)

QP Code: ELE/Q0123

Version: 3.0

NSQF Level: 5

Electronics Sector Skills Council of India || 155, 2nd Floor, ESC House Okhla Industrial Area-Phase 3  
New Delhi- 110020 || email:anu@essc-india.org



## Qualification Pack

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## Qualification Pack

### ELE/Q0123: Package Design Engineer (Semiconductor)

#### Brief Job Description

Package Design Engineer (Semiconductor) works on Designing software & responsible for designing & defining of layouts for different type of IC Packages. He is also responsible for Test Program preparation for all type of IC Packages available with product or Research & Development Team. He also assists in the design verifications.

#### Personal Attributes

The individual must have an aptitude for details along with analytical and problem-solving skills. The person should be able to work in co-ordination with others. The individual should be able to communicate appropriately, both verbally and in writing.

#### Applicable National Occupational Standards (NOS)

##### Compulsory NOS:

1. [ELE/N0156: Package Design](#)
2. [ELE/N0157: Electrical Simulation](#)
3. [ELE/N0158: Thermal Simulation](#)
4. [ELE/N0159: Mechanical Simulation](#)
5. [DGT/VSQ/N0102: Employability Skills \(60 Hours\)](#)

#### Qualification Pack (QP) Parameters

<b>Sector</b>	Electronics
<b>Sub-Sector</b>	Semiconductor & Components
<b>Occupation</b>	Product Design-S&C
<b>Country</b>	India
<b>NSQF Level</b>	5
<b>Credits</b>	19
<b>Aligned to NCO/ISCO/ISIC Code</b>	NCO-2015/3118.0302

## Qualification Pack

<b>Minimum Educational Qualification &amp; Experience</b>	<p>Completed 2nd year of UG (UG Diploma) (Physics/ Electronics/Electrical/Mechanical) with 1.5 years of experience Relevant Experience in Semiconductor &amp; Components</p> <p>OR</p> <p>Completed 3 year diploma after 10th (Electronics/Electrical/Mechanical) with 3 Years of experience Relevant Experience in Semiconductor &amp; Components</p> <p>OR</p> <p>Previous relevant Qualification of NSQF Level (4.5) with 1.5 years of experience Relevant Experience in Semiconductor &amp; Components</p>
<b>Minimum Level of Education for Training in School</b>	10th Class
<b>Pre-Requisite License or Training</b>	NA
<b>Minimum Job Entry Age</b>	18 Years
<b>Last Reviewed On</b>	NA
<b>Next Review Date</b>	31/10/2025
<b>NSQC Approval Date</b>	20/06/2025
<b>Version</b>	3.0
<b>Reference code on NQR</b>	QG-05-EH-03992-2025-V3-ESSCI
<b>NQR Version</b>	3.0

### Remarks:

NA
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## Qualification Pack

### ELE/N0156: Package Design

#### Description

The NOS unit is about design and optimize semiconductor packaging through detailed schematic, netlist, substrate, and wire bond development to ensure manufacturable, cost-effective, and high-performance products.

#### Scope

The scope covers the following :

- Package Design
- Netlist
- Substrate Design
- Wire bond Diagram Design

#### Elements and Performance Criteria

##### *Package Design*

To be competent, the user/individual on the job must be able to:

- PC1.** Sketch rough package as per specification
- PC2.** Discuss with each process engineer for processability
- PC3.** Discuss with each process engineer for Material usage
- PC4.** Feasibility study and characterization methods to optimize best design
- PC5.** Package Design tool expert
- PC6.** Create Design File using the optimized physical design
- PC7.** Figure out best design that help engineers to convert into products
- PC8.** Good understanding of material, package dimensions, package structures, semiconductors etc.
- PC9.** Good Understanding of Each package process flow
- PC10.** Basic Knowledge of each Equipment)
- PC11.** prepare full SOP and release to production
- PC12.** perform special requirements is needed

##### *Netlist*

To be competent, the user/individual on the job must be able to:

- PC13.** Understanding of wafer (Device/Die) PAD locations & their electrical characteristics
- PC14.** Understanding of output pins and their electrical characteristics
- PC15.** Based on above two points Create Schematic
- PC16.** Create netlist using above schematic
- PC17.** Use this netlist to create package design
- PC18.** Good understanding of design, functionalities such as layer, location, bending angles, thickness, layer thickness etc

## Qualification Pack

**PC19.** Optional - Can start building mechanical sample to verify this design

**PC20.** Clear all check points using mechanical samples

### *Substrate Design*

To be competent, the user/individual on the job must be able to:

**PC21.** Create substrate layout

**PC22.** Create multiple metal layers as per customer requirements

**PC23.** Create and optimize vias

**PC24.** Optimize for best core materials

**PC25.** Optimize for best Dimensions (Vias, Core Material, Solder Mask etc)

### *Wire bond Diagram Design*

To be competent, the user/individual on the job must be able to:

**PC26.** Based on netlist create wire bond diagram

**PC27.** Optimize wire bond loop

**PC28.** Optimize wire bond thickness

**PC29.** Optimize substrate wire bond PAD's dimensions

**PC30.** Based on all above parameters wire bonding should be low cost and processible design

## Knowledge and Understanding (KU)

The individual on the job needs to know and understand:

**KU1.** how to identify the die dimensions and back grinding processes

**KU2.** the importance of analyzing the die attach film/material properties and thickness requirements

**KU3.** how to evaluate the curing and attaching conditions of die-attach film/material

**KU4.** how to recognize the structure of stacking (die thickness and substrate thickness with die attach film/material thickness)

**KU5.** how to specify the bonding force, pick & place location, curing parameters inside the oven, etc.

**KU6.** the procedure of setting up all process parameters, such as bonding force, placements, attaching speed, adhesive thickness, wafer and substrate location moving speed, etc.

**KU7.** how to set to run dummy samples

**KU8.** the importance of taking measurements to ensure all dimensions are within specification

**KU9.** the importance of repeating the criteria until the specified criteria are met

**KU10.** how to turn major input parameters into Standard Operating Procedure (SOP)

**KU11.** the importance of preparing full SOP and releasing it to production, and considering the special requirements, if required

**KU12.** the importance of identifying the parameters for the new product verification process

**KU13.** how to prepare a copy of the old recipe to perform a similar program

**KU14.** the importance of identifying and making changes as per the product specification requirements



## Qualification Pack

- KU15.** how to run dummy measurements, Calculate Process Capability (CPK), Process Performance (PPK), and other quality parameters
- KU16.** the importance and process of verifying the real product using various quality and reliability checks
- KU17.** the importance of preparing for mass production after all QCs are passed
- KU18.** how to use Automatic Computer-Aided Design (AUTO-CAD) software
- KU19.** the procedure of preparing process flow with clear specifications, such as temperature, speed, water flow, vacuumed, etc.
- KU20.** the importance of preparing the SOP with pictures, visuals, data charts to ensure it is more understandable to operators
- KU21.** the importance of identifying the training needs of operators on SOP flow
- KU22.** the process of preparing the travelling card with the defined process or program name/ code
- KU23.** the importance of ensuring the quality of all the travelling cards released to production
- KU24.** the importance of performing regular inspection of programs
- KU25.** the importance of performing regular inspection of data, such as yield, failure, etc.
- KU26.** the importance of preparing for emergencies

## Generic Skills (GS)

User/individual on the job needs to know how to:

- GS1.** maintain work-related notes and records
- GS2.** read the relevant literature to get the latest updates about the field of work
- GS3.** listen attentively to understand the information/ instructions being shared
- GS4.** communicate politely and professionally
- GS5.** plan and prioritize tasks to ensure timely completion
- GS6.** co-ordinate with the co-workers to achieve the work objectives
- GS7.** evaluate all possible solutions to a problem to select the best one
- GS8.** take quick decisions to deal with workplace emergencies/ accidents

## Qualification Pack

### Assessment Criteria

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<i>Package Design</i>	<b>22</b>	<b>26</b>	-	<b>4</b>
<b>PC1.</b> Sketch rough package as per specification	-	-	-	-
<b>PC2.</b> Discuss with each process engineer for processibility	-	-	-	-
<b>PC3.</b> Discuss with each process engineer for Material usage	-	-	-	-
<b>PC4.</b> Feasibility study and characterization methods to optimize best design	-	-	-	-
<b>PC5.</b> Package Design tool expert	-	-	-	-
<b>PC6.</b> Create Design File using the optimized physical design	-	-	-	-
<b>PC7.</b> Figure out best design that help engineers to convert into products	-	-	-	-
<b>PC8.</b> Good understanding of material, package dimensions, package structures, semiconductors etc.	-	-	-	-
<b>PC9.</b> Good Understanding of Each package process flow	-	-	-	-
<b>PC10.</b> Basic Knowledge of each Equipment)	-	-	-	-
<b>PC11.</b> prepare full SOP and release to production	-	-	-	-
<b>PC12.</b> perform special requirements is needed	-	-	-	-
<i>Netlist</i>	<b>8</b>	<b>12</b>	-	<b>2</b>
<b>PC13.</b> Understanding of wafer (Device/Die) PAD locations & their electrical characteristics	-	-	-	-
<b>PC14.</b> Understanding of output pins and their electrical characteristics	-	-	-	-
<b>PC15.</b> Based on above two points Create Schematic	-	-	-	-



## Qualification Pack

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<b>PC16.</b> Create netlist using above schematic	-	-	-	-
<b>PC17.</b> Use this netlist to create package design	-	-	-	-
<b>PC18.</b> Good understanding of design, functionalities such as layer, location, bending angles, thickness, layer thickness etc	-	-	-	-
<b>PC19.</b> Optional - Can start building mechanical sample to verify this design	-	-	-	-
<b>PC20.</b> Clear all check points using mechanical samples	-	-	-	-
<i>Substrate Design</i>	<b>5</b>	<b>6</b>	-	<b>2</b>
<b>PC21.</b> Create substrate layout	-	-	-	-
<b>PC22.</b> Create multiple metal layers as per customer requirements	-	-	-	-
<b>PC23.</b> Create and optimize vias	-	-	-	-
<b>PC24.</b> Optimize for best core materials	-	-	-	-
<b>PC25.</b> Optimize for best Dimensions (Vias, Core Material, Solder Mask etc)	-	-	-	-
<i>Wire bond Diagram Design</i>	<b>5</b>	<b>6</b>	-	<b>2</b>
<b>PC26.</b> Based on netlist create wire bond diagram	-	-	-	-
<b>PC27.</b> Optimize wire bond loop	-	-	-	-
<b>PC28.</b> Optimize wire bond thickness	-	-	-	-
<b>PC29.</b> Optimize substrate wire bond PAD's dimensions	-	-	-	-
<b>PC30.</b> Based on all above parameters wire bonding should be low cost and processible design	-	-	-	-
<b>NOS Total</b>	<b>40</b>	<b>50</b>	-	<b>10</b>

## Qualification Pack

### National Occupational Standards (NOS) Parameters

<b>NOS Code</b>	ELE/N0156
<b>NOS Name</b>	Package Design
<b>Sector</b>	Electronics
<b>Sub-Sector</b>	Semiconductor & Components
<b>Occupation</b>	Production-S&C
<b>NSQF Level</b>	5
<b>Credits</b>	5
<b>Version</b>	2.0
<b>Last Reviewed Date</b>	20/06/2025
<b>Next Review Date</b>	31/10/2025
<b>NSQC Clearance Date</b>	20/06/2025

## Qualification Pack

### ELE/N0157: Electrical Simulation

#### Description

The NOS unit is about to verify and optimize semiconductor package designs through electrical simulations and analysis of signal integrity, RLC parameters, and reliability to ensure performance and early issue detection.

#### Scope

The scope covers the following :

- To Verify Package Design

#### Elements and Performance Criteria

##### *To Verify Package Design*

To be competent, the user/individual on the job must be able to:

- PC1.** Good Understanding of fabrication processes
- PC2.** Good understanding of device structure
- PC3.** Good understanding of material properties (Electrical Behaviour) of device and package
- PC4.** Good understanding of All materials Electrical Characteristics
- PC5.** Good Understanding of Interaction of Die/Device with package material
- PC6.** Expert in electrical simulation tool
- PC7.** Use the package design file to simulate it
- PC8.** Good understanding of Signal integrity
- PC9.** Good Understanding of RLC Parameters
- PC10.** Good understanding of Eye Diagrams
- PC11.** How to observe & create Signal integrity, RLC Parameters and Eye Diagrams
- PC12.** Find out early-stage electrical issues
- PC13.** Fix those issues
- PC14.** Release DOE to verify simulation parameters
- PC15.** Find out best leg based on DOE and verify it by releasing bigger sample size
- PC16.** Simulate the design for realibility condition tool
- PC17.** Document every process, Parameters etc

#### Knowledge and Understanding (KU)

The individual on the job needs to know and understand:

- KU1.** the importance of defining all die dimensions, stacking combination, and wire bonding parameters
- KU2.** how to define sample size for each lot to measure all dimensions

## Qualification Pack

- KU3.** the importance of preparing the measurement techniques in the SOP for operators
- KU4.** the importance of analyzing the collected data and performing statistical analysis to determine if it is within the specification before releasing the lot to the next step
- KU5.** how to identify the consumables pack specifications
- KU6.** the importance of regularly inspecting for each consumable
- KU7.** how to identify any failure at die attach
- KU8.** the importance of ensuring wire bond passes through failure analysis
- KU9.** the importance of checking the root cause of each failure
- KU10.** the importance of defining the short term and long-term actions or failures to reduce the failure rate
- KU11.** how to prepare an 8D report
- KU12.** the importance of preparing the yield data collection for each product
- KU13.** how to analyze the yield
- KU14.** the importance of analyzing data using statistical methods
- KU15.** the importance of recording all failures along with actions to avoid future failure
- KU16.** the importance of performing Research and Development (R&D) and preparing strategies for further improvements
- KU17.** the working principle of machines to improve UPH
- KU18.** how to develop the design of experiments (DOE) expertise
- KU19.** the process of running statistical tools, such as the Joint Manpower Program (JMP)
- KU20.** the importance of regularly interacting with customers, suppliers, and internal teams
- KU21.** the process generating designs using Auto-CAD

## Generic Skills (GS)

User/individual on the job needs to know how to:

- GS1.** write work-related notes and maintain relevant records
- GS2.** read the relevant literature to get the latest updates about the field of work
- GS3.** listen attentively to understand the information/ instructions being shared by the speaker
- GS4.** communicate politely and professionally
- GS5.** plan and prioritize tasks to ensure timely completion
- GS6.** evaluate all possible solutions to a problem to select the best one
- GS7.** co-ordinate with the co-workers to achieve work objectives
- GS8.** identify possible disruptions to work and take appropriate preventive measures
- GS9.** take quick decisions to deal with workplace emergencies/ accidents

## Qualification Pack

### Assessment Criteria

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<i>To Verify Package Design</i>	<b>40</b>	<b>50</b>	<b>-</b>	<b>10</b>
<b>PC1.</b> Good Understanding of fabrication processes	-	-	-	-
<b>PC2.</b> Good understanding of device structure	-	-	-	-
<b>PC3.</b> Good understanding of material properties (Electrical Behaviour) of device and package	-	-	-	-
<b>PC4.</b> Good understanding of All materials Electrical Characteristics	-	-	-	-
<b>PC5.</b> Good Understanding of Interaction of Die/Device with package material	-	-	-	-
<b>PC6.</b> Expert in electrical simulation tool	-	-	-	-
<b>PC7.</b> Use the package design file to simulate it	-	-	-	-
<b>PC8.</b> Good understanding of Signal integrity	-	-	-	-
<b>PC9.</b> Good Understanding of RLC Parameters	-	-	-	-
<b>PC10.</b> Good understanding of Eye Diagrams	-	-	-	-
<b>PC11.</b> How to observe & create Signal integrity, RLC Parameters and Eye Diagrams	-	-	-	-
<b>PC12.</b> Find out early-stage electrical issues	-	-	-	-
<b>PC13.</b> Fix those issues	-	-	-	-
<b>PC14.</b> Release DOE to verify simulation parameters	-	-	-	-
<b>PC15.</b> Find out best leg based on DOE and verify it by releasing bigger sample size	-	-	-	-
<b>PC16.</b> Simulate the design for realibility condition tool	-	-	-	-
<b>PC17.</b> Document every process, Parameters etc	-	-	-	-



## Qualification Pack

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
NOS Total	40	50	-	10



## Qualification Pack

### National Occupational Standards (NOS) Parameters

<b>NOS Code</b>	ELE/N0157
<b>NOS Name</b>	Electrical Simulation
<b>Sector</b>	Electronics
<b>Sub-Sector</b>	Semiconductor & Components
<b>Occupation</b>	Production-S&C
<b>NSQF Level</b>	5
<b>Credits</b>	4
<b>Version</b>	2.0
<b>Last Reviewed Date</b>	20/06/2025
<b>Next Review Date</b>	31/10/2025
<b>NSQC Clearance Date</b>	20/06/2025



## Qualification Pack

### ELE/N0158: Thermal Simulation

#### Description

The NOS unit is about to verify and optimize semiconductor package designs using thermal simulations to assess material behavior, identify early thermal issues, and ensure reliability under defined operating conditions.

#### Scope

The scope covers the following :

- To Verify Package Design

#### Elements and Performance Criteria

##### *To Verify Package Design*

To be competent, the user/individual on the job must be able to:

- PC1.** good Understanding of fabrication processes
- PC2.** good understanding of device structure
- PC3.** good understanding of material properties (thermal behaviour) of device and package
- PC4.** good understanding of All materials thermal Characteristics
- PC5.** good understanding of Interaction of Die/Device with package material
- PC6.** expert in thermal simulation tool
- PC7.** use the package design file to simulate it
- PC8.** good understanding of thermal parameters
- PC9.** good Understanding of melting point, CTE, TG, Curing Temperature etc.
- PC10.** good understanding of behaviour of PC.9 Properties
- PC11.** how to observe & create thermal simulation diagram
- PC12.** find out early-stage thermal issues
- PC13.** fix those issues
- PC14.** release DOE to verify simulation parameters
- PC15.** find out best leg based on DOE and verify it by releasing bigger sample size
- PC16.** simulate the design for realibility condition tool

#### Knowledge and Understanding (KU)

The individual on the job needs to know and understand:

- KU1.** the use of Auto CAD and other equivalent design tools
- KU2.** the wafer structure and processing, and wire material properties
- KU3.** the importance of determining the customer requirements and collecting data from competitors' specs

## Qualification Pack

- KU4.** how to perform reverse analysis to get the die to attach and wire bonding specifications
- KU5.** the importance of identifying the critical and normal dimension requirements as per the customer requirements
- KU6.** the importance and process of defining the dimension specifications to meet the customer requirements
- KU7.** the Joint Electron Device Engineering Council (JEDEC) standard
- KU8.** the customer bonding diagram
- KU9.** the importance of specifying the wire bonding material that fulfils the bonding drawing and electrical, mechanical, and thermal specifications
- KU10.** how to perform drawing activities bonding drawing
- KU11.** how to verify the die-attach staking structure
- KU12.** how to verify rubber tip for die attach and capillary for wire bonding drawing
- KU13.** how to identify magazine drawing and cassette drawing

## Generic Skills (GS)

User/individual on the job needs to know how to:

- GS1.** write work-related notes and maintain relevant records
- GS2.** read the relevant literature to get the latest updates about the field of work
- GS3.** listen attentively to understand the information/ instructions being shared by the speaker
- GS4.** communicate politely and professionally
- GS5.** plan and prioritize tasks to ensure timely completion
- GS6.** evaluate all possible solutions to a problem to select the best one
- GS7.** co-ordinate with the co-workers to achieve work objectives
- GS8.** identify possible disruptions to work and take appropriate preventive measures
- GS9.** take quick decisions to deal with workplace emergencies/ accidents

## Qualification Pack

### Assessment Criteria

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<i>To Verify Package Design</i>	<b>40</b>	<b>50</b>	-	<b>10</b>
<b>PC1.</b> good Understanding of fabrication processes	-	-	-	-
<b>PC2.</b> good understanding of device structure	-	-	-	-
<b>PC3.</b> good understanding of material properties (thermal behaviour) of device and package	-	-	-	-
<b>PC4.</b> good understanding of All materials thermal Characteristics	-	-	-	-
<b>PC5.</b> good understanding of Interaction of Die/Device with package material	-	-	-	-
<b>PC6.</b> expert in thermal simulation tool	-	-	-	-
<b>PC7.</b> use the package design file to simulate it	-	-	-	-
<b>PC8.</b> good understanding of thermal parameters	-	-	-	-
<b>PC9.</b> good Understanding of melting point, CTE, TG, Curing Temperature etc.	-	-	-	-
<b>PC10.</b> good understanding of behaviour of PC.9 Properties	-	-	-	-
<b>PC11.</b> how to observe & create thermal simulation diagram	-	-	-	-
<b>PC12.</b> find out early-stage thermal issues	-	-	-	-
<b>PC13.</b> fix those issues	-	-	-	-
<b>PC14.</b> release DOE to verify simulation parameters	-	-	-	-
<b>PC15.</b> find out best leg based on DOE and verify it by releasing bigger sample size	-	-	-	-
<b>PC16.</b> simulate the design for realibility condition tool	-	-	-	-



### Qualification Pack

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
NOS Total	40	50	-	10

## Qualification Pack

### National Occupational Standards (NOS) Parameters

<b>NOS Code</b>	ELE/N0158
<b>NOS Name</b>	Thermal Simulation
<b>Sector</b>	Electronics
<b>Sub-Sector</b>	Semiconductor & Components
<b>Occupation</b>	Production-S&C
<b>NSQF Level</b>	5
<b>Credits</b>	4
<b>Version</b>	2.0
<b>Last Reviewed Date</b>	20/06/2025
<b>Next Review Date</b>	31/10/2025
<b>NSQC Clearance Date</b>	20/06/2025

## Qualification Pack

### ELE/N0159: Mechanical Simulation

#### Description

The NOS unit is about to Verify and optimize semiconductor package designs using mechanical simulations and testing to evaluate material strength, identify early mechanical issues, and ensure structural reliability under environmental conditions.

#### Scope

The scope covers the following :

- To Verify Package Design

#### Elements and Performance Criteria

##### *To Verify Package Design*

To be competent, the user/individual on the job must be able to:

- PC1.** good understanding of fabrication processes
- PC2.** good understanding of device structure
- PC3.** good understanding of material properties (Mechanical Behaviour) of device and package
- PC4.** good understanding of All materials Mechanical Characteristics
- PC5.** good Understanding of Interaction of Die/Device with package material
- PC6.** expert in Mechanical simulation tool
- PC7.** use the package design file to simulate it
- PC8.** good understanding of material strength and its behaviour with temperature and humidity
- PC9.** good Understanding of melting point, CTE, TG, Curing Temperature etc.
- PC10.** good understanding of behaviour of PC.9 Properties on mechanical strength of each layer separately and combined package
- PC11.** how to observe & create mechanical simulation diagram
- PC12.** find out early-stage mechanical issues
- PC13.** fix those issues
- PC14.** release DOE to verify simulation parameters
- PC15.** find out best leg based on DOE and verify it by releasing bigger sample size
- PC16.** simulate the design for realibility condition tool
- PC17.** good understanding of physical verification tool as such as Mechanical testers (To measure tensile strength, breaking strength etc. )
- PC18.** document every process, Parameters etc

#### Knowledge and Understanding (KU)

The individual on the job needs to know and understand:

- KU1.** the use of Auto CAD and other equivalent design tools

## Qualification Pack

- KU2.** the wafer structure and processing, and wire material properties
- KU3.** the importance of determining the customer requirements and collecting data from competitors' specs
- KU4.** how to perform reverse analysis to get the die to attach and wire bonding specifications
- KU5.** the importance of identifying the critical and normal dimension requirements as per the customer requirements
- KU6.** the importance and process of defining the dimension specifications to meet the customer requirements
- KU7.** the Joint Electron Device Engineering Council (JEDEC) standard
- KU8.** the customer bonding diagram
- KU9.** the importance of specifying the wire bonding material that fulfils the bonding drawing and electrical, mechanical, and thermal specifications
- KU10.** how to perform drawing activities bonding drawing
- KU11.** how to verify the die-attach staking structure
- KU12.** how to verify rubber tip for die attach and capillary for wire bonding drawing
- KU13.** how to identify magazine drawing and cassette drawing

## Generic Skills (GS)

User/individual on the job needs to know how to:

- GS1.** write work-related notes and maintain relevant records
- GS2.** read the relevant literature to get the latest updates about the field of work
- GS3.** listen attentively to understand the information/ instructions being shared by the speaker
- GS4.** communicate politely and professionally
- GS5.** plan and prioritize tasks to ensure timely completion
- GS6.** evaluate all possible solutions to a problem to select the best one
- GS7.** co-ordinate with the co-workers to achieve work objectives
- GS8.** identify possible disruptions to work and take appropriate preventive measures
- GS9.** take quick decisions to deal with workplace emergencies/ accidents



## Qualification Pack

### Assessment Criteria

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<i>To Verify Package Design</i>	<b>40</b>	<b>50</b>	-	<b>10</b>
<b>PC1.</b> good understanding of fabrication processes	-	-	-	-
<b>PC2.</b> good understanding of device structure	-	-	-	-
<b>PC3.</b> good understanding of material properties (Mechanical Behaviour) of device and package	-	-	-	-
<b>PC4.</b> good understanding of All materials Mechanical Characteristics	-	-	-	-
<b>PC5.</b> good Understanding of Interaction of Die/Device with package material	-	-	-	-
<b>PC6.</b> expert in Mechanical simulation tool	-	-	-	-
<b>PC7.</b> use the package design file to simulate it	-	-	-	-
<b>PC8.</b> good understanding of material strength and its behaviour with temperature and humidity	-	-	-	-
<b>PC9.</b> good Understanding of melting point, CTE, TG, Curing Temperature etc.	-	-	-	-
<b>PC10.</b> good understanding of behaviour of PC.9 Properties on mechanical strength of each layer separately and combined package	-	-	-	-
<b>PC11.</b> how to observe & create mechanical simulation diagram	-	-	-	-
<b>PC12.</b> find out early-stage mechanical issues	-	-	-	-
<b>PC13.</b> fix those issues	-	-	-	-
<b>PC14.</b> release DOE to verify simulation parameters	-	-	-	-
<b>PC15.</b> find out best leg based on DOE and verify it by releasing bigger sample size	-	-	-	-
<b>PC16.</b> simulate the design for realibity condition tool	-	-	-	-

### Qualification Pack

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<b>PC17.</b> good understanding of physical verification tool as such as Mechanical testers (To measure tensile strength, breaking strength etc. )	-	-	-	-
<b>PC18.</b> document every process, Parameters etc	-	-	-	-
<b>NOS Total</b>	<b>40</b>	<b>50</b>	<b>-</b>	<b>10</b>

## Qualification Pack

### National Occupational Standards (NOS) Parameters

<b>NOS Code</b>	ELE/N0159
<b>NOS Name</b>	Mechanical Simulation
<b>Sector</b>	Electronics
<b>Sub-Sector</b>	Semiconductor & Components
<b>Occupation</b>	Production-S&C
<b>NSQF Level</b>	5
<b>Credits</b>	4
<b>Version</b>	2.0
<b>Last Reviewed Date</b>	20/06/2025
<b>Next Review Date</b>	31/10/2025
<b>NSQC Clearance Date</b>	20/06/2025

## Qualification Pack

### DGT/VSQ/N0102: Employability Skills (60 Hours)

#### Description

This unit is about employability skills, Constitutional values, becoming a professional in the 21st Century, digital, financial, and legal literacy, diversity and Inclusion, English and communication skills, customer service, entrepreneurship, and apprenticeship, getting ready for jobs and career development.

#### Scope

The scope covers the following :

- Introduction to Employability Skills
- Constitutional values - Citizenship
- Becoming a Professional in the 21st Century
- Basic English Skills
- Career Development & Goal Setting
- Communication Skills
- Diversity & Inclusion
- Financial and Legal Literacy
- Essential Digital Skills
- Entrepreneurship
- Customer Service
- Getting ready for Apprenticeship & Jobs

#### Elements and Performance Criteria

##### *Introduction to Employability Skills*

To be competent, the user/individual on the job must be able to:

- PC1.** identify employability skills required for jobs in various industries
- PC2.** identify and explore learning and employability portals

##### *Constitutional values – Citizenship*

To be competent, the user/individual on the job must be able to:

- PC3.** recognize the significance of constitutional values, including civic rights and duties, citizenship, responsibility towards society etc. and personal values and ethics such as honesty, integrity, caring and respecting others, etc.
- PC4.** follow environmentally sustainable practices

##### *Becoming a Professional in the 21st Century*

To be competent, the user/individual on the job must be able to:

- PC5.** recognize the significance of 21st Century Skills for employment
- PC6.** practice the 21st Century Skills such as Self-Awareness, Behaviour Skills, time management, critical and adaptive thinking, problem-solving, creative thinking, social and cultural awareness, emotional awareness, learning to learn for continuous learning etc. in personal and professional life

##### *Basic English Skills*

To be competent, the user/individual on the job must be able to:

## Qualification Pack

- PC7.** use basic English for everyday conversation in different contexts, in person and over the telephone
- PC8.** read and understand routine information, notes, instructions, mails, letters etc. written in English
- PC9.** write short messages, notes, letters, e-mails etc. in English

### *Career Development & Goal Setting*

To be competent, the user/individual on the job must be able to:

- PC10.** understand the difference between job and career
- PC11.** prepare a career development plan with short- and long-term goals, based on aptitude

### *Communication Skills*

To be competent, the user/individual on the job must be able to:

- PC12.** follow verbal and non-verbal communication etiquette and active listening techniques in various settings
- PC13.** work collaboratively with others in a team

### *Diversity & Inclusion*

To be competent, the user/individual on the job must be able to:

- PC14.** communicate and behave appropriately with all genders and PwD
- PC15.** escalate any issues related to sexual harassment at workplace according to POSH Act

### *Financial and Legal Literacy*

To be competent, the user/individual on the job must be able to:

- PC16.** select financial institutions, products and services as per requirement
- PC17.** carry out offline and online financial transactions, safely and securely
- PC18.** identify common components of salary and compute income, expenses, taxes, investments etc
- PC19.** identify relevant rights and laws and use legal aids to fight against legal exploitation

### *Essential Digital Skills*

To be competent, the user/individual on the job must be able to:

- PC20.** operate digital devices and carry out basic internet operations securely and safely
- PC21.** use e- mail and social media platforms and virtual collaboration tools to work effectively
- PC22.** use basic features of word processor, spreadsheets, and presentations

### *Entrepreneurship*

To be competent, the user/individual on the job must be able to:

- PC23.** identify different types of Entrepreneurship and Enterprises and assess opportunities for potential business through research
- PC24.** develop a business plan and a work model, considering the 4Ps of Marketing Product, Price, Place and Promotion
- PC25.** identify sources of funding, anticipate, and mitigate any financial/ legal hurdles for the potential business opportunity

### *Customer Service*

To be competent, the user/individual on the job must be able to:

- PC26.** identify different types of customers
- PC27.** identify and respond to customer requests and needs in a professional manner.

## Qualification Pack

**PC28.** follow appropriate hygiene and grooming standards

*Getting ready for apprenticeship & Jobs*

To be competent, the user/individual on the job must be able to:

**PC29.** create a professional Curriculum vitae (Résumé)

**PC30.** search for suitable jobs using reliable offline and online sources such as Employment exchange, recruitment agencies, newspapers etc. and job portals, respectively

**PC31.** apply to identified job openings using offline /online methods as per requirement

**PC32.** answer questions politely, with clarity and confidence, during recruitment and selection

**PC33.** identify apprenticeship opportunities and register for it as per guidelines and requirements

## Knowledge and Understanding (KU)

The individual on the job needs to know and understand:

**KU1.** need for employability skills and different learning and employability related portals

**KU2.** various constitutional and personal values

**KU3.** different environmentally sustainable practices and their importance

**KU4.** Twenty first (21st) century skills and their importance

**KU5.** how to use English language for effective verbal (face to face and telephonic) and written communication in formal and informal set up

**KU6.** importance of career development and setting long- and short-term goals

**KU7.** about effective communication

**KU8.** POSH Act

**KU9.** Gender sensitivity and inclusivity

**KU10.** different types of financial institutes, products, and services

**KU11.** how to compute income and expenditure

**KU12.** importance of maintaining safety and security in offline and online financial transactions

**KU13.** different legal rights and laws

**KU14.** different types of digital devices and the procedure to operate them safely and securely

**KU15.** how to create and operate an e- mail account and use applications such as word processors, spreadsheets etc.

**KU16.** how to identify business opportunities

**KU17.** types and needs of customers

**KU18.** how to apply for a job and prepare for an interview

**KU19.** apprenticeship scheme and the process of registering on apprenticeship portal

## Generic Skills (GS)

User/individual on the job needs to know how to:

**GS1.** read and write different types of documents/instructions/correspondence

**GS2.** communicate effectively using appropriate language in formal and informal settings



## Qualification Pack

- GS3.** behave politely and appropriately with all
- GS4.** how to work in a virtual mode
- GS5.** perform calculations efficiently
- GS6.** solve problems effectively
- GS7.** pay attention to details
- GS8.** manage time efficiently
- GS9.** maintain hygiene and sanitization to avoid infection



## Qualification Pack

### Assessment Criteria

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<i>Introduction to Employability Skills</i>	<b>1</b>	<b>1</b>	-	-
<b>PC1.</b> identify employability skills required for jobs in various industries	-	-	-	-
<b>PC2.</b> identify and explore learning and employability portals	-	-	-	-
<i>Constitutional values – Citizenship</i>	<b>1</b>	<b>1</b>	-	-
<b>PC3.</b> recognize the significance of constitutional values, including civic rights and duties, citizenship, responsibility towards society etc. and personal values and ethics such as honesty, integrity, caring and respecting others, etc.	-	-	-	-
<b>PC4.</b> follow environmentally sustainable practices	-	-	-	-
<i>Becoming a Professional in the 21st Century</i>	<b>2</b>	<b>4</b>	-	-
<b>PC5.</b> recognize the significance of 21st Century Skills for employment	-	-	-	-
<b>PC6.</b> practice the 21st Century Skills such as Self-Awareness, Behaviour Skills, time management, critical and adaptive thinking, problem-solving, creative thinking, social and cultural awareness, emotional awareness, learning to learn for continuous learning etc. in personal and professional life	-	-	-	-
<i>Basic English Skills</i>	<b>2</b>	<b>3</b>	-	-
<b>PC7.</b> use basic English for everyday conversation in different contexts, in person and over the telephone	-	-	-	-
<b>PC8.</b> read and understand routine information, notes, instructions, mails, letters etc. written in English	-	-	-	-
<b>PC9.</b> write short messages, notes, letters, e-mails etc. in English	-	-	-	-
<i>Career Development &amp; Goal Setting</i>	<b>1</b>	<b>2</b>	-	-

### Qualification Pack

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<b>PC10.</b> understand the difference between job and career	-	-	-	-
<b>PC11.</b> prepare a career development plan with short- and long-term goals, based on aptitude	-	-	-	-
<i>Communication Skills</i>	<b>2</b>	<b>2</b>	-	-
<b>PC12.</b> follow verbal and non-verbal communication etiquette and active listening techniques in various settings	-	-	-	-
<b>PC13.</b> work collaboratively with others in a team	-	-	-	-
<i>Diversity &amp; Inclusion</i>	<b>1</b>	<b>2</b>	-	-
<b>PC14.</b> communicate and behave appropriately with all genders and PwD	-	-	-	-
<b>PC15.</b> escalate any issues related to sexual harassment at workplace according to POSH Act	-	-	-	-
<i>Financial and Legal Literacy</i>	<b>2</b>	<b>3</b>	-	-
<b>PC16.</b> select financial institutions, products and services as per requirement	-	-	-	-
<b>PC17.</b> carry out offline and online financial transactions, safely and securely	-	-	-	-
<b>PC18.</b> identify common components of salary and compute income, expenses, taxes, investments etc	-	-	-	-
<b>PC19.</b> identify relevant rights and laws and use legal aids to fight against legal exploitation	-	-	-	-
<i>Essential Digital Skills</i>	<b>3</b>	<b>4</b>	-	-
<b>PC20.</b> operate digital devices and carry out basic internet operations securely and safely	-	-	-	-
<b>PC21.</b> use e- mail and social media platforms and virtual collaboration tools to work effectively	-	-	-	-
<b>PC22.</b> use basic features of word processor, spreadsheets, and presentations	-	-	-	-

### Qualification Pack

Assessment Criteria for Outcomes	Theory Marks	Practical Marks	Project Marks	Viva Marks
<i>Entrepreneurship</i>	<b>2</b>	<b>3</b>	-	-
<b>PC23.</b> identify different types of Entrepreneurship and Enterprises and assess opportunities for potential business through research	-	-	-	-
<b>PC24.</b> develop a business plan and a work model, considering the 4Ps of Marketing Product, Price, Place and Promotion	-	-	-	-
<b>PC25.</b> identify sources of funding, anticipate, and mitigate any financial/ legal hurdles for the potential business opportunity	-	-	-	-
<i>Customer Service</i>	<b>1</b>	<b>2</b>	-	-
<b>PC26.</b> identify different types of customers	-	-	-	-
<b>PC27.</b> identify and respond to customer requests and needs in a professional manner.	-	-	-	-
<b>PC28.</b> follow appropriate hygiene and grooming standards	-	-	-	-
<i>Getting ready for apprenticeship &amp; Jobs</i>	<b>2</b>	<b>3</b>	-	-
<b>PC29.</b> create a professional Curriculum vitae (Résumé)	-	-	-	-
<b>PC30.</b> search for suitable jobs using reliable offline and online sources such as Employment exchange, recruitment agencies, newspapers etc. and job portals, respectively	-	-	-	-
<b>PC31.</b> apply to identified job openings using offline /online methods as per requirement	-	-	-	-
<b>PC32.</b> answer questions politely, with clarity and confidence, during recruitment and selection	-	-	-	-
<b>PC33.</b> identify apprenticeship opportunities and register for it as per guidelines and requirements	-	-	-	-
<b>NOS Total</b>	<b>20</b>	<b>30</b>	-	-

## Qualification Pack

### National Occupational Standards (NOS) Parameters

<b>NOS Code</b>	DGT/VSQ/N0102
<b>NOS Name</b>	Employability Skills (60 Hours)
<b>Sector</b>	Cross Sectoral
<b>Sub-Sector</b>	Professional Skills
<b>Occupation</b>	Employability
<b>NSQF Level</b>	4
<b>Credits</b>	2
<b>Version</b>	1.0
<b>Last Reviewed Date</b>	08/05/2025
<b>Next Review Date</b>	31/10/2025
<b>NSQC Clearance Date</b>	08/05/2025

## Assessment Guidelines and Assessment Weightage

### Assessment Guidelines

1. Criteria for assessment for each Qualification Pack will be created by the Sector Skill Council. Each Performance Criteria (PC) will be assigned marks proportional to its importance in NOS. SSC will also lay down proportion of marks for Theory and Skills Practical for each PC.
2. The assessment for the theory part will be based on knowledge bank of questions created by the SSC.
3. Individual assessment agencies will create unique question papers for theory part for each candidate at each examination/training centre (as per assessment criteria below.)
4. Individual assessment agencies will create unique evaluations for skill practical for every student at each examination/training centre based on these criteria.
5. To pass the Qualification Pack, every trainee should score a minimum of 70% in every NOS.
6. In case of successfully passing only certain number of NOS's, the trainee is eligible to take subsequent assessment on the balance NOS's to pass the Qualification Pack

### Minimum Aggregate Passing % at QP Level : 70

## Qualification Pack

(Please note: Every Trainee should score a minimum aggregate passing percentage as specified above, to successfully clear the Qualification Pack assessment.)

## Assessment Weightage

Compulsory NOS

National Occupational Standards	Theory Marks	Practical Marks	Project Marks	Viva Marks	Total Marks	Weightage
ELE/N0156.Package Design	40	50	-	10	100	20
ELE/N0157.Electrical Simulation	40	50	-	10	100	20
ELE/N0158.Thermal Simulation	40	50	-	10	100	20
ELE/N0159.Mechanical Simulation	40	50	-	10	100	20
DGT/VSQ/N0102.Employability Skills (60 Hours)	20	30	-	-	50	20
<b>Total</b>	<b>180</b>	<b>230</b>	<b>-</b>	<b>40</b>	<b>450</b>	<b>100</b>

## Qualification Pack

### Acronyms

<b>NOS</b>	National Occupational Standard(s)
<b>NSQF</b>	National Skills Qualifications Framework
<b>QP</b>	Qualifications Pack
<b>TVET</b>	Technical and Vocational Education and Training

## Qualification Pack

### Glossary

<b>Sector</b>	Sector is a conglomeration of different business operations having similar business and interests. It may also be defined as a distinct subset of the economy whose components share similar characteristics and interests.
<b>Sub-sector</b>	Sub-sector is derived from a further breakdown based on the characteristics and interests of its components.
<b>Occupation</b>	Occupation is a set of job roles, which perform similar/ related set of functions in an industry.
<b>Job role</b>	Job role defines a unique set of functions that together form a unique employment opportunity in an organisation.
<b>Occupational Standards (OS)</b>	OS specify the standards of performance an individual must achieve when carrying out a function in the workplace, together with the Knowledge and Understanding (KU) they need to meet that standard consistently. Occupational Standards are applicable both in the Indian and global contexts.
<b>Performance Criteria (PC)</b>	Performance Criteria (PC) are statements that together specify the standard of performance required when carrying out a task.
<b>National Occupational Standards (NOS)</b>	NOS are occupational standards which apply uniquely in the Indian context.
<b>Qualifications Pack (QP)</b>	QP comprises the set of OS, together with the educational, training and other criteria required to perform a job role. A QP is assigned a unique qualifications pack code.
<b>Unit Code</b>	Unit code is a unique identifier for an Occupational Standard, which is denoted by an 'N'
<b>Unit Title</b>	Unit title gives a clear overall statement about what the incumbent should be able to do.
<b>Description</b>	Description gives a short summary of the unit content. This would be helpful to anyone searching on a database to verify that this is the appropriate OS they are looking for.
<b>Scope</b>	Scope is a set of statements specifying the range of variables that an individual may have to deal with in carrying out the function which have a critical impact on quality of performance required.



## Qualification Pack

<b>Knowledge and Understanding (KU)</b>	Knowledge and Understanding (KU) are statements which together specify the technical, generic, professional and organisational specific knowledge that an individual needs in order to perform to the required standard.
<b>Organisational Context</b>	Organisational context includes the way the organisation is structured and how it operates, including the extent of operative knowledge managers have of their relevant areas of responsibility.
<b>Technical Knowledge</b>	Technical knowledge is the specific knowledge needed to accomplish specific designated responsibilities.
<b>Core Skills/ Generic Skills (GS)</b>	Core skills or Generic Skills (GS) are a group of skills that are the key to learning and working in today's world. These skills are typically needed in any work environment in today's world. These skills are typically needed in any work environment. In the context of the OS, these include communication related skills that are applicable to most job roles.
<b>Electives</b>	Electives are NOS/set of NOS that are identified by the sector as contributive to specialization in a job role. There may be multiple electives within a QP for each specialized job role. Trainees must select at least one elective for the successful completion of a QP with Electives.
<b>Options</b>	Options are NOS/set of NOS that are identified by the sector as additional skills. There may be multiple options within a QP. It is not mandatory to select any of the options to complete a QP with Options.